

ISSUE CLASSIFICATION	
Class	Subclass

N

PATENT NUMBER

U.S. **UTILITY** Patent Application

O.I.P.E.	PATENT DATE
SCANNED <i>HKm</i> Q.A. <i>AP 4</i>	

APPLICATION NO. 09/879724	CONT/PRIOR	CLASS 257	SUBCLASS 347	ART UNIT 2811	EXAMINER S. J. J. J.
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## APPLICANTS

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**TITLE**

Leaky, thermally conductive insulator material (LTCIM) in semiconductor-on-insulator (SOI) structure

PTO-2040  
12/99

## ISSUING CLASSIFICATION

[illegible]

<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>	<b>DRAWINGS</b>			<b>CLAIMS ALLOWED</b>	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner) (Date)			<b>NOTICE OF ALLOWANCE MAILED</b>	
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<b>ISSUE FEE</b>					
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<input type="checkbox"/> The terminal ____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner) (Date)			<b>ISSUE BATCH NUMBER</b>	
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